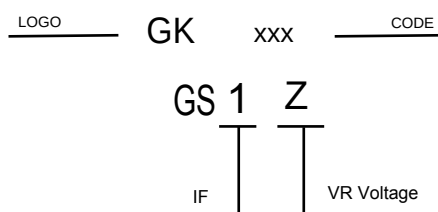
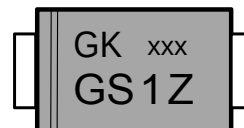


FEATURES

- * Ideal for surface mount applications
- * Easy pick and place
- * Built-in strain relief
- * High surge current capability

MECHANICAL DATA

- * Case: Molded plastic
- * Epoxy: UL 94V-0 rate flame retardant
- * Terminals: Solder plated, solderable per MIL-STD-202F method 208 guranteed
- * Polarity: Color band denotes cathode end
- * Mounting position: Any
- * Weight: 0.063 gram



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating 25°C ambient temperature unieess otherwies specified.
Single phase half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Parameter	Symbols	GS1Z	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	2000	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	1	A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I_{FSM}	30	A
Maximum Instantaneous Forward Voltage at 1 A	V_F	1.15	V
Maximum Reverse Current $T_J = 25\text{ }^{\circ}\text{C}$ $T_J = 125\text{ }^{\circ}\text{C}$	I_R	5 50	μA
Typical Junction Capacitance ¹⁾	C_j	20	pF
Typical Thermal Resistance ²⁾	$R_{\theta JA}$	95	$^{\circ}\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{stg}	-55 ~ +150	$^{\circ}\text{C}$

Measured at 1 MHz and applied reverse voltage of 4 V D.C
P.C.B. mounted with 0.2 X 0.2" (5 X 5 mm) copper pad areas.

RATING AND CHARACTERISTIC CURVES

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

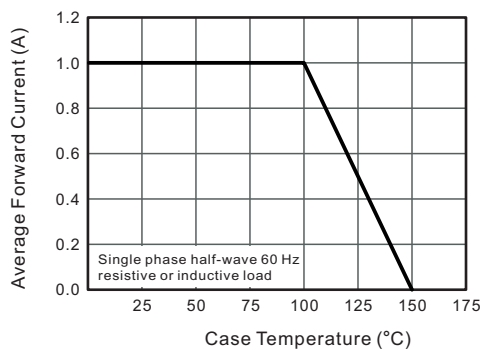


FIG.2-TYPICAL FORWARD CHARACTERISTICS

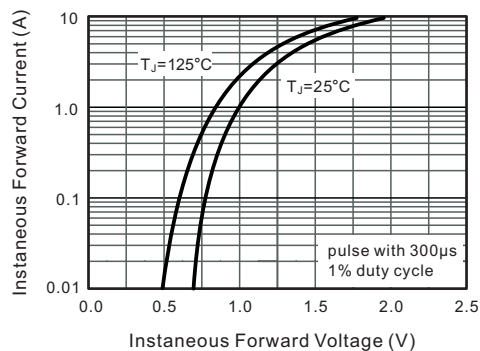


FIG.3 - TYPICAL REVERSE CHARACTERISTICS

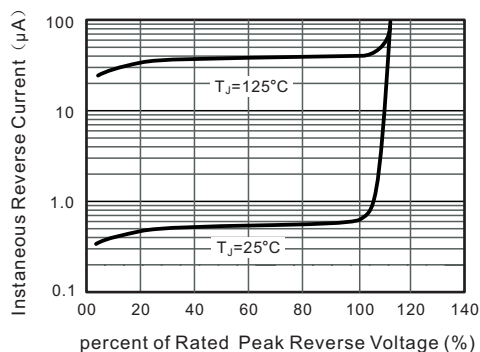


FIG.4-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

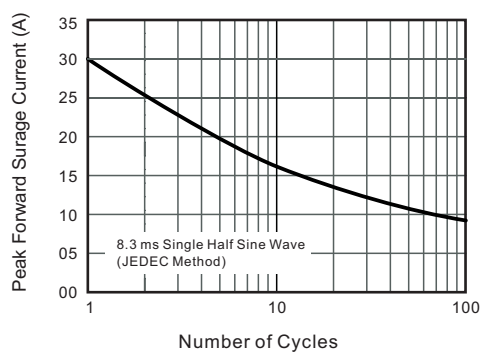
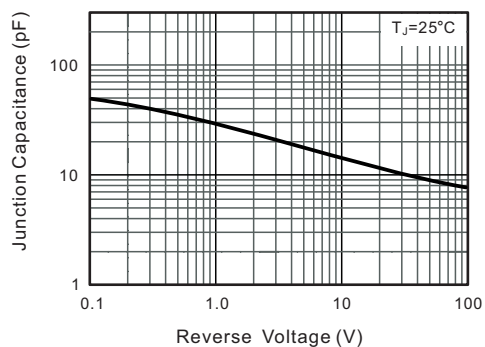
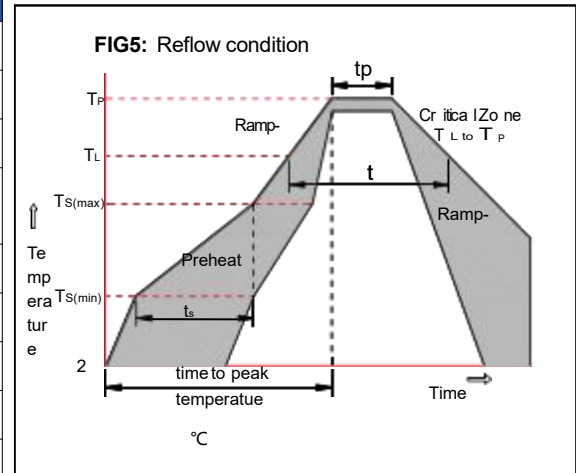


FIG.5-TYPICAL JUNCTION CAPACITANCE



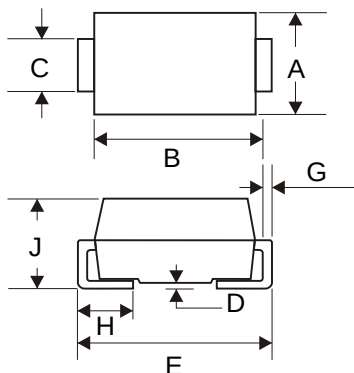
Soldering parameters

Reflow Condition		Pb-Free assembly (see as below)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150°C
	-Temperature Max($T_{s(max)}$)	+200°C
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp (T_L) to peak)		3°C/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature(T_L)(Liquid us)	+217°C
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_P)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		30 secs. Max
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp (T_P)		8 min. Max
Do not exceed		+260°C

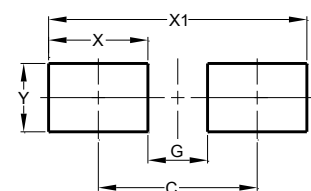


Package Dimensions & Suggested Pad Layout

SMA

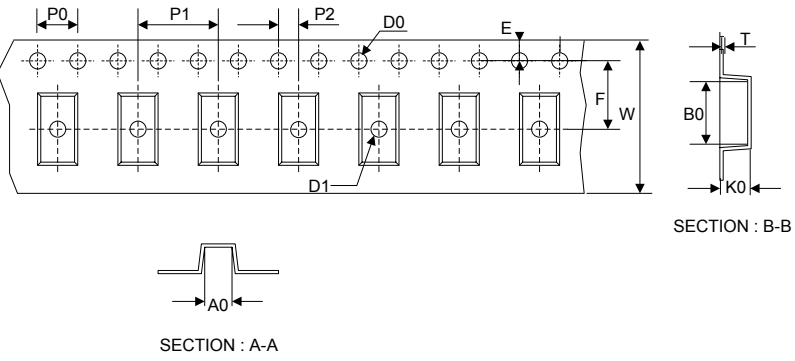
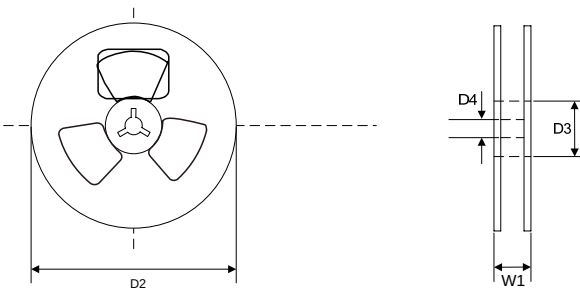
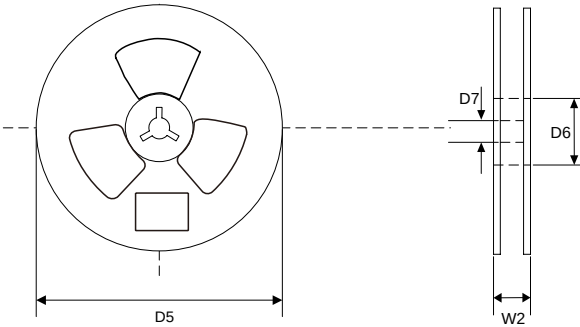
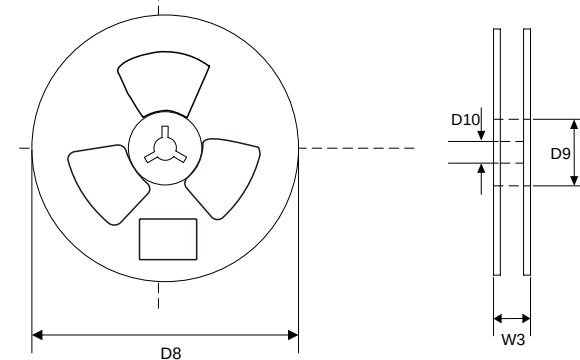


SMA		
Dim	Min	Max
A	2.40	2.79
B	3.99	4.50
C	1.32	1.47
D	-	0.20
E	4.93	5.28
G	0.15	0.31
H	0.76	1.52
J	1.98	2.29
All Dimensions in mm		



Dimensions	Value (in mm)
C	4.20
G	1.90
X	2.30
X1	6.50
Y	2.00

Tape & reel specification

Tape		Symbol	Dimension (mm)
		P0	4.00±0.20
		P1	8.00±0.20
		P2	2.00±0.20
		D0	1.60±0.20
		D1	1.60±0.20
		E	1.75±0.20
		F	5.50±0.15
		W	12.00±0.25
		A0	2.75±0.20
		B0	5.25±0.20
		K0	2.45±0.25
		T	0.20±0.10
7" Reel		D2	176.0±5.0
		D3	55.0Min.
		D4	14.0±2.5
		W1	14.0±2.5
		Quantity: 2000PCS	
11" Reel		D5	276.0±5.0
		D6	71.0Min.
		D7	14.0±2.5
		W2	14.0±2.5
		Quantity: 5000PCS	
13" Reel		D8	330.0±5.0
		D9	73.0Min.
		D10	14.0±2.5
		W3	14.0±2.5
		Quantity: 5000PCS	